

# Radiation defect dynamics in 3C-, 4H-, and 6H-SiC studied by pulsed ion beams

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## ABSTRACT

Radiation damage behavior of SiC depends on its lattice structure. Here, we use a pulsed-ion-beam method to study defect interaction dynamics in 6H-SiC and damage buildup in 4H- and 6H-SiC irradiated at 100 °C with 500 keV Ar ions. These results are compared with previously reported data for Ar-ion-irradiated 3C- and 4H-SiC. We find that, for these irradiation conditions, damage buildup in 3C- and 6H-SiC is statistically indistinguishable and is significantly more efficient than in 4H-SiC. Within a stimulated amorphization model, 4H-SiC is described by a reduced amorphization cross-section constant, while the point defect cluster production cross-section is the same (within experimental errors) for the three polytypes studied. Moreover, 4H-SiC exhibits slower defect relaxation dynamics than 3C- and 6H-SiC. These results clearly demonstrate the importance of the lattice structure in damage buildup and defect interaction dynamics in SiC.

## 1. Introduction

Silicon carbide is a prototypical nuclear ceramic material [1]. It is also a wide-band-gap semiconductor used in electronics, where ion implantation is a critical device processing step [2]. Understanding radiation damage in SiC is beneficial for both nuclear and electronic applications of this material. Hence, numerous previous studies of radiation effects in different polytypes of SiC have been reported (see, for example, [1–13]). Above room temperature, the accumulation of stable lattice disorder in SiC is dominated by so called dynamic annealing (DA) [3–13], which refers to the migration and interaction of point defects ballistically generated by the ion beam. These mobile (and, hence, unstable) point defects could interact with each other and with pre-existing otherwise stable defect structures in the lattice. The DA is typically experimentally manifested as the dependence of the defect formation efficiency on sample temperature, the defect generation rate, and the density of collision cascades. For regimes with pronounced DA, damage buildup in SiC is complex and remains poorly understood [1–13].

Defect migration and interaction processes depend on the lattice structure. Hence, in regimes with pronounced DA, damage buildup is expected to be different in different polytypes of SiC [11,9]. A recent pulsed ion beam study have indeed revealed a pronounced difference in defect interaction dynamics in 4H- and 3C-SiC bombarded at 100 °C with 500 keV Ar ions [11]. In the present paper, we study damage

buildup and defect interaction dynamics in 6H-SiC and damage buildup in 4H-SiC bombarded at 100 °C with 500 keV Ar ions. We compare our findings with previous results for 3C- and 4H-SiC polytypes irradiated under the same conditions [9–12]. We find that, for these irradiation conditions, 3C- and 6H-SiC exhibit very similar damage buildup and defect interaction dynamics, while 4H-SiC behaves differently.

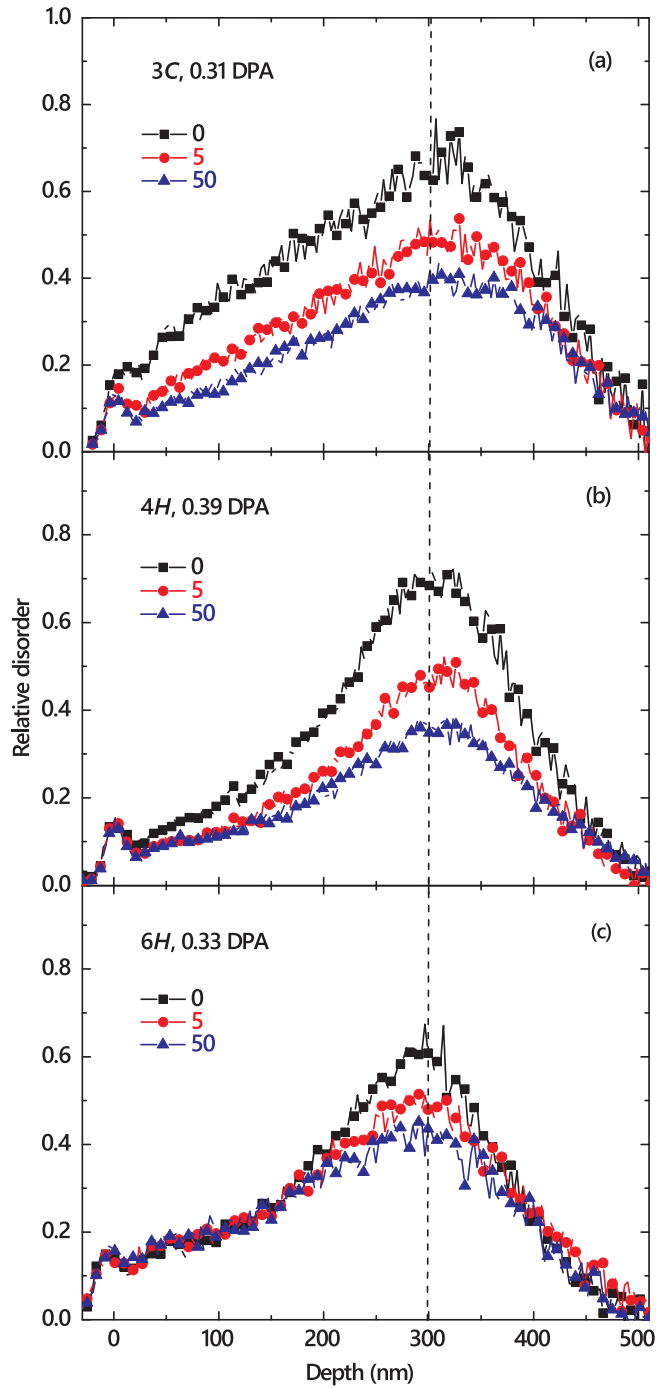
## 2. Experimental

We used single crystals of high-purity semi-insulating (0001) 4H-SiC and (0001) 6H-SiC obtained from II-VI, Inc. The crystal quality of as-received wafers was verified by measuring a minimum 2 MeV He ion channeling yield of  $\sim 1.5\%$ , consistent across the wafer. To improve thermal contact, samples were attached to a Cu target holder with conductive silver paste.

The 4 MV ion accelerator (National Electrostatics Corporation, model 4UH) at Lawrence Livermore National Laboratory was used for both ion irradiation and ion beam analysis. Samples were bombarded at 100 °C with 500 keV  $^{40}\text{Ar}$  ions at 7° off the sample normal direction to minimize channeling. All irradiation experiments were performed in a broad beam mode (rather than in a raster mode) [14]. In each irradiation run with pulsed beams, the total ion fluence ( $\Phi$ ) was split into a train of equal square pulses. Each pulse had the same dose rate ( $F_{on}$ ) of  $1.9 \times 10^{13} \text{ cm}^{-2} \text{ s}^{-1}$  and a duration ( $t_{on}$ ) of 1 ms and was separated from the subsequent pulse by  $t_{off}$  that was varied between 0 and 100 ms.

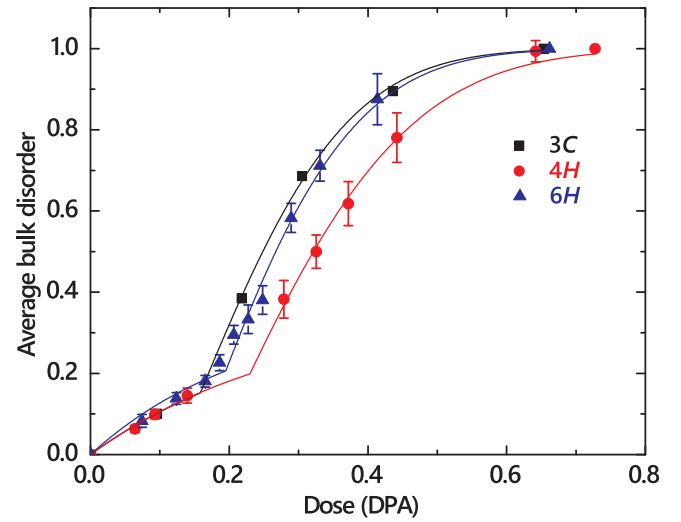
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**Fig. 1.** Selected depth profiles of relative disorder in (a) 3C-, (b) 4H-, and (c) 6H-SiC irradiated at 100 °C with a pulsed beam of 500 keV Ar ions with  $F_{on} = 1.9 \times 10^{13} \text{ cm}^{-2} \text{ s}^{-1}$ ,  $t_{on} = 1 \text{ ms}$ , and different  $t_{off}$  values given in the legends (in units of ms). The total fluences used are also shown in the legends. For clarity, only every 10th experimental point is depicted. The vertical dashed line shows the position of the maximum of the nuclear energy loss profile of Ar ions.

Depth profiles of stable lattice disorder in the Si sublattice were measured by ion channeling *ex-situ* at room temperature with 2 MeV  $^4\text{He}^+$  ions incident along the [0001] direction and backscattered into a detector at 164° relative to the incident beam direction. Raw channeling spectra were analyzed with one of the conventional algorithms [15] for extracting depth profiles of relative disorder. Values of average relative bulk disorder ( $n$ , with  $n = 1$  corresponding to full amorphization) were obtained by averaging depth profiles of relative disorder over 15 channels ( $\sim 40 \text{ nm}$ ) centered on the bulk damage peak



**Fig. 2.** Fluence dependencies of average relative bulk disorder in 3C-, 4H-, and 6H-SiC bombarded at 100 °C with a continuous beam of 500 keV Ar ions with a dose rate of  $1.9 \times 10^{13} \text{ cm}^{-2} \text{ s}^{-1}$ . Solid lines are results of fitting with a stimulated amorphization model described in the text.

maximum. Error bars of  $n$  are standard deviations.

The depth profile of the lattice vacancies ballistically-generated by 500 keV Ar ions was calculated with the TRIM code (version SRIM-2013.00, full cascade calculations) [16] as described in [13] with an atomic concentration of SiC of  $9.64 \times 10^{22} \text{ cm}^{-3}$  and threshold energies for atomic displacements of 20 and 35 eV for C and Si sublattices, respectively. To convert to displacements per atom (DPA) at the maximum of the nuclear energy loss profile, ion fluence (in units of ion  $\text{cm}^{-2}$ ) is multiplied by  $8.5 \times 10^{-16} \text{ DPA cm}^2 \text{ ion}^{-1}$ .

### 3. Results and discussion

#### 3.1. Damage buildup for continuous beam irradiation

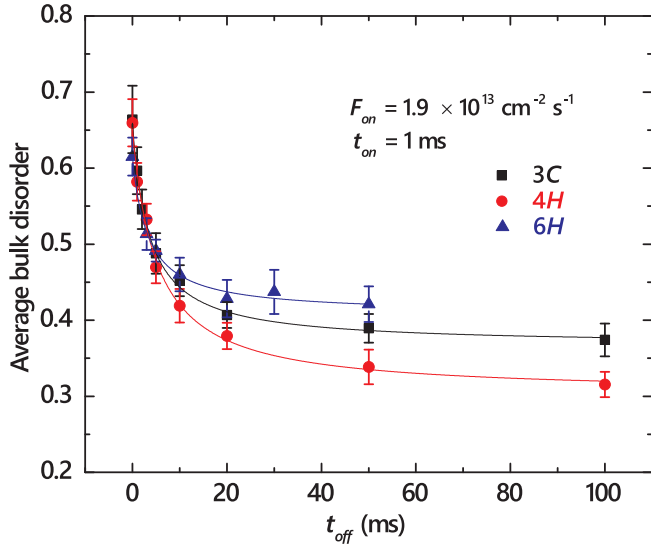
Figs. 1(a)–1(c) compare damage–depth profiles for the three polytypes irradiated at 100 °C to similar total fluences with continuous (i.e.,  $t_{off} = 0$ ) and pulsed beams with different  $t_{off}$  values (given in the legends) and all the other irradiation parameters kept the same. In this and the following two figures, the new results for damage buildup (with a continuous ion beam) in 4H-SiC and 6H-SiC and new defect dynamics results (with a pulsed ion beam) for 6H-SiC are compared with previous data for 3C-SiC and 4H-SiC taken from [10,11], respectively. It is seen from Fig. 1 that, for all three polytypes, depth profiles are bimodal, with the main broad peak centered on the maximum of the nuclear energy loss profile (marked by a vertical dashed line) and the second much smaller intensity peak at the sample surface. Hence, the sample surface in all three polytypes appears to have a limited role in damage accumulation for these irradiation conditions.

Fig. 2 shows bulk damage buildup curves [i.e.,  $n(\Phi)$  dependencies for continuous beam bombardment] for the three polytypes studied. It is seen from Fig. 2 that, within experimental errors, damage buildup curves for 3C- and 6H-SiC overlap, while 4H-SiC exhibits a lower damage buildup efficiency for fluences  $\gtrsim 0.2 \text{ DPA}$ . All three damage buildup curves have a sigmoidal shape, which is consistent with a number previous reports [3,8,9,12,13]. Such a sigmoidal shape of  $n(\Phi)$  dependencies suggests nucleation-limited (i.e., stimulated) defect accumulation. Shown in Fig. 2 by solid lines are results of fitting with a phenomenological stimulated amorphization model from [9]. Within this model, the total damage level is given by the following expressions:

**Table 1**

Effective time constant of DA ( $\tau$ ), the DA efficiency ( $\xi_{DA}$ ), and parameters of the stimulated amorphization model, described in the text, for three different polytypes of SiC bombarded at 100 °C with 500 keV Ar ions.

Polytype	$\tau$ (ms)	$\xi_{DA}$ (%)	$\sigma_{cluster}$ (DPA <sup>-1</sup> )	$\xi_{amorph}$ (DPA <sup>-2</sup> )	$\Phi_{crit}$ (DPA)	$\Phi_{amorph}$ (DPA)
3C	$3.4 \pm 0.3$	$44.4 \pm 0.8$	$3.5 \pm 0.5$	$25.1 \pm 1.3$	$0.16 \pm 0.01$	$0.51 \pm 0.01$
4H	$4.8 \pm 0.5$	$53.3 \pm 1.3$	$3.5 \pm 0.4$	$16.5 \pm 1.1$	$0.23 \pm 0.01$	$0.65 \pm 0.02$
6H	$3.1 \pm 0.4$	$33.3 \pm 1.1$	$4.4 \pm 0.5$	$24.6 \pm 1.8$	$0.19 \pm 0.01$	$0.53 \pm 0.02$



**Fig. 3.** Average relative bulk disorder in 3C-, 4H-, and 6H-SiC bombarded at 100 °C with a pulsed beam of 500 keV Ar ions with  $F_{on} = 1.9 \times 10^{13} \text{ cm}^{-2} \text{ s}^{-1}$  and  $t_{on} = 1 \text{ ms}$  as a function of the passive portion of the beam duty cycle ( $t_{off}$ ). Fitting curves with the second order decay equation are shown by solid lines.

$$f_{total} = f_{amorph} + f_{cluster} = f_{amorph} + f_{cluster}^{sat} [1 - \exp(-\sigma_{cluster} \Phi)] (1 - f_{amorph}),$$

$$f_{amorph} = h(\Phi - \Phi_{crit}) (1 - \exp[-\frac{\xi_{amorph}}{2} (\Phi^2 - \Phi_{crit}^2)]).$$

(1)

Here,  $f_{amorph}$  is the fraction of atoms in the amorphous phase,  $f_{cluster}$  is the atomic fraction of stable point defect clusters,  $\sigma_{cluster}$  is the cluster production cross-section,  $f_{cluster}^{sat}$  is the maximum saturation fraction of defect clusters in the lattice,  $h(x)$  is the Heaviside step function [ $h(x) = 0$  for  $x < 0$  and  $h(x) = 1$  for  $x \geq 0$ ],  $\Phi_{crit}$  is the critical fluence above which amorphization proceeds, and  $\xi_{amorph}$  is the amorphization cross-section constant. We used  $f_{cluster}^{sat} = 36\%$  and a fitting procedure described in detail in [13].

Fig. 2 shows that such a stimulated amorphization model provides an excellent fit for all the cases. Table 1 lists the fitting parameters:  $\sigma_{cluster}$ ,  $\xi_{amorph}$ , and  $\Phi_{crit}$  as well as the amorphization fluence ( $\Phi_{amorph}$ , taken as the  $\Phi$  corresponding to ). It is seen from Table 1 that, within fitting errors,  $\sigma_{cluster}$  is the same for all three polytypes, while  $\xi_{amorph}$  is much lower for 4H-SiC than for the other two polytypes. This quantifies the above statements that all three damage buildup curves in Fig. 2 essentially overlap for  $\Phi \lesssim 0.2$  DPA and damage buildup becomes less efficient in 4H-SiC for higher fluences. A larger  $\Phi_{crit}$  for 4H-SiC also reflects that the inflection point of the sigmoid is at higher fluence for 4H-SiC than for the other two polytypes. Interestingly, our recent systematic studies of 3C-SiC [9,12,13] have also revealed that  $\xi_{amorph}$ , rather than  $\sigma_{cluster}$ , is changing in damage buildup experiments with variable temperature, ion mass, and the dose rate. Hence, the amorphization process for  $\Phi \gtrsim \Phi_{crit}$  is critically sensitive to the lattice structure, dose rate, collision cascade density, and sample temperature, while the accumulation of point defect clusters appears to be insensitive to these parameters.

### 3.2. Defect relaxation dynamics studied by the pulsed ion beam method

Fig. 1 also shows that, for all three polytypes irradiated with a pulsed Ar ion beam,  $n$  decreases with increasing  $t_{off}$ , while the damage level at the sample surface remains unchanged, suggesting different dynamic mechanisms of bulk and surface disordering. This behavior is qualitatively similar to that found in previous studies (with pulsed beams of 500 keV Ar ions) of 3C-SiC at 100 °C and 4H-SiC in the  $T$  range of 25–250 °C [10–12].

Fig. 3 summarizes  $n(t_{off})$  dependencies for the three polytypes. Solid lines in Fig. 3 are fits of the data via the Marquardt–Levenberg algorithm [17] with the second order decay equation ( $n(t_{off}) = n_{\infty} + \frac{n(0) - n_{\infty}}{1 + \frac{t_{off}}{\tau}}$ ). Here,  $\tau$  is the effective time constant of DA, and  $n_{\infty}$  is relative disorder for  $t_{off} \gg \tau$ . All the  $n(t_{off})$  dependencies from Fig. 3 obey the second order decay better than the first order (i.e., exponential) decay. Table 1 lists the two fitting parameters:  $\tau$  and  $\xi_{DA}$ , which is the DA efficiency defined as before [10–12]:  $\xi_{DA} = \frac{n(0) - n_{\infty}}{n(0)}$ . As discussed in detail previously [18], for our choice of pulsing parameters,  $\xi_{DA}$  is the magnitude of the dose-rate effect; i.e., the difference between  $n$  for continuous beam irradiation with dose rates of  $F = F_{on}$  and  $F \rightarrow 0$ . Table 1 shows that the three polytypes are characterized by different  $\xi_{DA}$  values, with 4H-SiC having the largest  $\xi_{DA}$ . The DA time constant ( $\tau$ ) is also larger for 4H-SiC than for the other two polytypes. These findings can be used to test future theoretical studies of the energetics of the defects dominating DA processes in different polytypes of SiC.

### 4. Summary

In summary, we have presented a comparative study of damage buildup and defect interaction dynamics in the three main polytypes of SiC (3C, 4H, and 6H) bombarded at 100 °C with 500 keV Ar ions. Our results have clearly demonstrated that DA in SiC depends on the lattice structure. These observations call for future systematic studies of both damage buildup and defect interaction dynamics at different temperatures and for irradiation conditions with different cascade densities. These experimental results can be used to benchmark models of radiation damage in different polytypes of SiC.

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